



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20220426001.0
Datasheet for CD74HC390, CDx4HCT390
Information Only**

Date: April 27, 2022
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

**Information Only
Attachments**

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
CD74HC390M	null
CD74HC390M96	null
CD74HC390E	null
CD74HCT390M96	null

Technical details of this Product Change follow on the next page(s).

Notification Number:	20220426001.0	Notification Date:	April 27, 2022
Title:	Datasheet for CD74HC390, CDx4HCT390		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.
The product datasheet(s) is being updated as summarized below.
The following change history provides further details.



CD74HC390, CD54HCT390, CD74HCT390
SCHS185E – SEPTEMBER 1997 – REVISED APRIL 2022

Changes from Revision D (November 2021) to Revision E (April 2022)

Page

- Corrected table 7-3, Q_C value 6 from H to L..... 10

The datasheet number will be changing.

Device Family	Change From:	Change To:
CD74HC390, CDx4HCT390	SCHS185D	SCHS185E

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/CD74HC390>

Error! Bookmark not defined.

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this notification:

None.

Product Affected:

5962-9098401MEA	CD54HCT390F3A	CD74HC390E	CD74HC390EE4
CD74HC390M	CD74HC390M96	CD74HCT390E	CD74HCT390EE4
CD74HCT390M	CD74HCT390M96	CD74HCT390MT	

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN_ww_admin_team@list.ti.com

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